

Silicon PIN Photodiode with Daylight Blocking Filter

Version 1.3

SFH 225 FA



Features:

- Especially suitable for applications of 880 nm
- Short-switching time (typ. 20 ns)
- 5 mm LED plastic package
- Also available on tape and reel
- The product qualification test plan is based on the guidelines of AEC-Q101-REV-C, Stress Test Qualification for Automotive Grade Discrete Semiconductors.

Applications

- Photointerrupters
- IR remote control of hi-fi and TV sets, dimmers, remote controls of various equipment

Ordering Information

Type:	Photocurrent	Ordering Code
	I_P [μ A] $\lambda = 870 \text{ nm}$, $E_e = 1 \text{ mW/cm}^2$, $V_R = 5 \text{ V}$	
SFH 225 FA	34 (≥ 25)	Q62702P1051

Maximum Ratings ($T_A = 25\text{ °C}$)

Parameter	Symbol	Values	Unit
Operating and storage temperature range	$T_{op}; T_{stg}$	-40 ... 100	°C
Reverse voltage	V_R	20	V
Total Power dissipation	P_{tot}	150	mW
ESD withstand voltage (acc. to ANSI/ ESDA/ JEDEC JS-001 - HBM)	V_{ESD}	2000	V

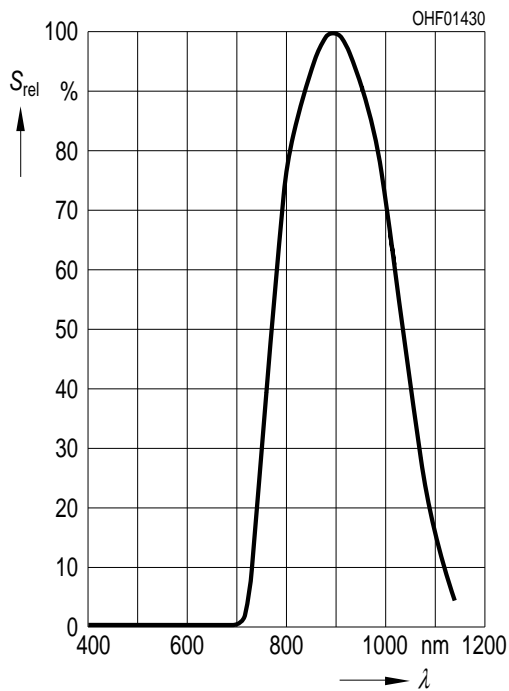
Characteristics ($T_A = 25\text{ °C}$)

Parameter	Symbol	Values	Unit
Photocurrent ($V_R = 5\text{ V}$, $E_e = 1\text{ mW/cm}^2$, $\lambda = 870\text{ nm}$)	(typ (min)) I_P	34 (≥ 25)	μA
Wavelength of max. sensitivity	(typ) $\lambda_{S\text{ max}}$	900	nm
Spectral range of sensitivity	(typ) $\lambda_{10\%}$	(typ) 740 ... 1120	nm
Radiant sensitive area	(typ) A	4.84	mm^2
Dimensions of radiant sensitive area	(typ) $L \times W$	2.2 x 2.2	mm x mm
Half angle	(typ) φ	± 60	°
Dark current ($V_R = 10\text{ V}$)	(typ (max)) I_R	2 (≤ 30)	nA
Spectral sensitivity of the chip ($\lambda = 870\text{ nm}$)	(typ) $S_{\lambda\text{ typ}}$	0.65	A / W
Quantum yield of the chip ($\lambda = 870\text{ nm}$)	(typ) η	0.93	Electrons / Photon
Open-circuit voltage ($E_e = 0.5\text{ mW/cm}^2$, $\lambda = 870\text{ nm}$)	(typ (min)) V_O	330 (≥ 250)	mV
Short-circuit current ($E_e = 0.5\text{ mW/cm}^2$, $\lambda = 870\text{ nm}$)	(typ) I_{SC}	17	μA
Rise and fall time ($V_R = 5\text{ V}$, $R_L = 50\ \Omega$, $\lambda = 850\text{ nm}$)	(typ) t_r, t_f	0.02	μs
Forward voltage ($I_F = 100\text{ mA}$, $E = 0$)	(typ) V_F	1.3	V
Capacitance ($V_R = 0\text{ V}$, $f = 1\text{ MHz}$, $E = 0$)	(typ) C_0	48	pF
Temperature coefficient of V_O	(typ) TC_V	-2.6	mV / K

Parameter		Symbol	Values	Unit
Temperature coefficient of I_{SC} ($\lambda = 870 \text{ nm}$)	(typ)	TC_1	0.1	% / K
Noise equivalent power ($V_R = 10 \text{ V}$, $\lambda = 870 \text{ nm}$)	(typ)	NEP	0.039	$\text{pW} / \text{Hz}^{1/2}$
Detection limit ($V_R = 10 \text{ V}$, $\lambda = 870 \text{ nm}$)	(typ)	D^*	5.6×10^{12}	$\text{cm} \times \text{Hz}^{1/2} / \text{W}$

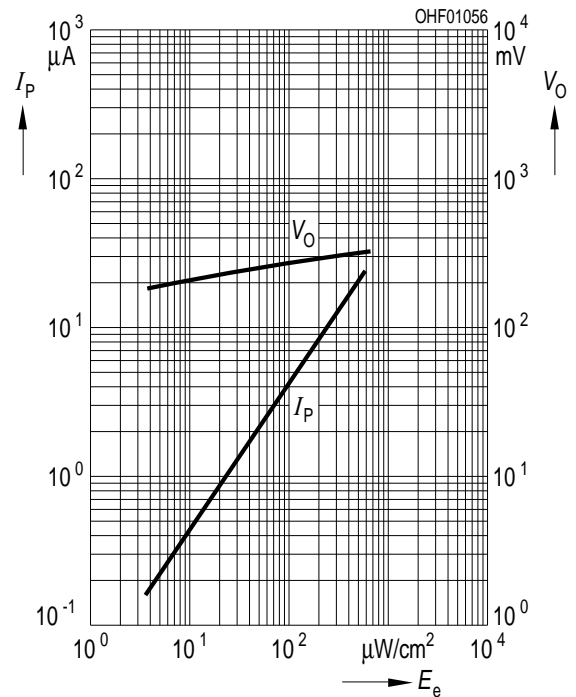
Relative Spectral Sensitivity ^{1) page 9}

$S_{rel} = f(\lambda)$



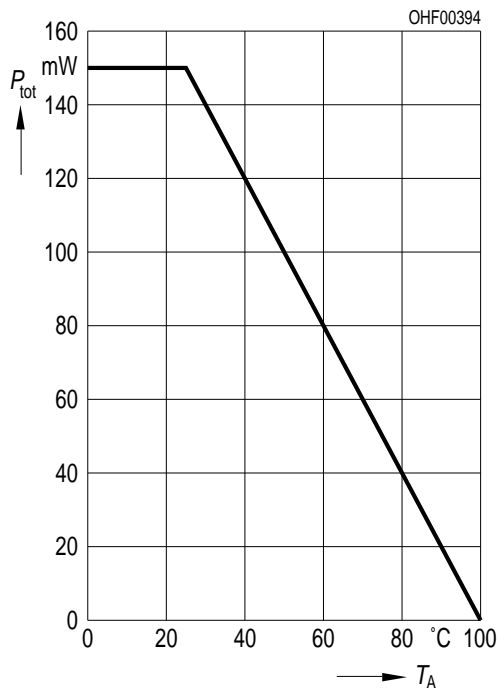
Photocurrent / Open-Circuit Voltage ^{1) page 9}

$I_P (V_R = 5 \text{ V}) / V_O = f(E_e)$



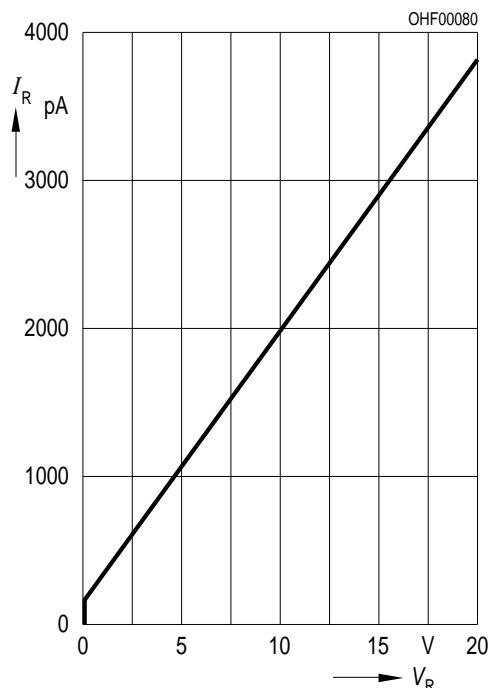
Power Consumption

$P_{tot} = f(T_A)$



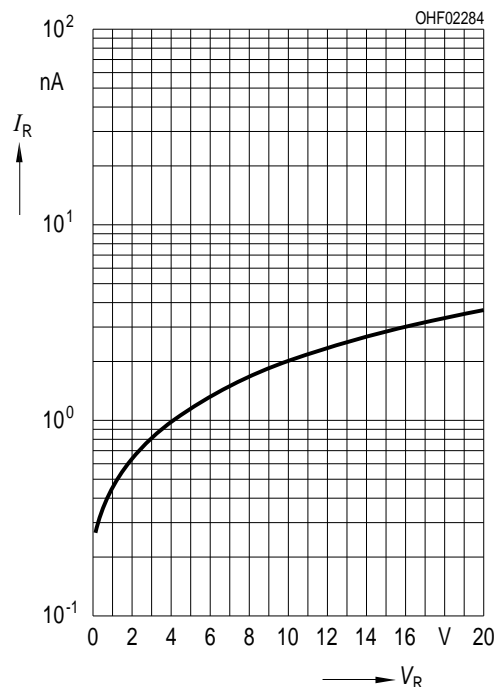
Dark Current ^{1) page 9}

$I_R = f(V_R), E = 0$



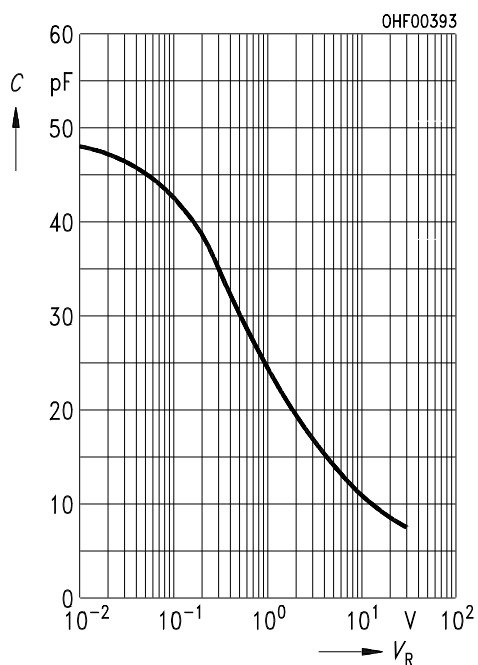
Dark Current ^{1) page 9}

$I_R = f(V_R), E = 0$



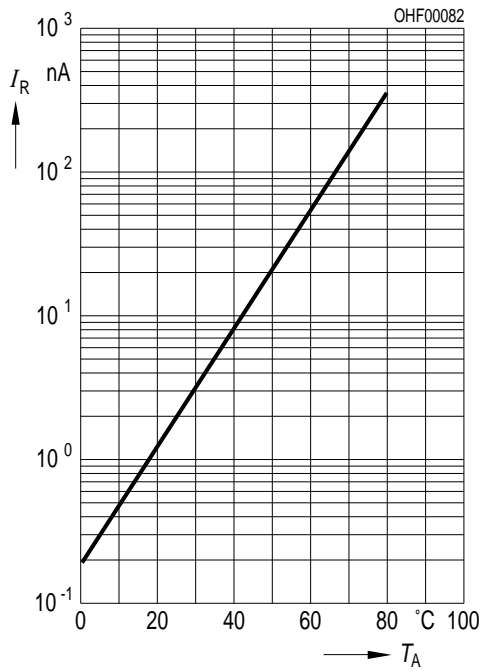
Capacitance ^{1) page 9}

$C = f(V_R), f = 1 \text{ MHz}, E = 0$



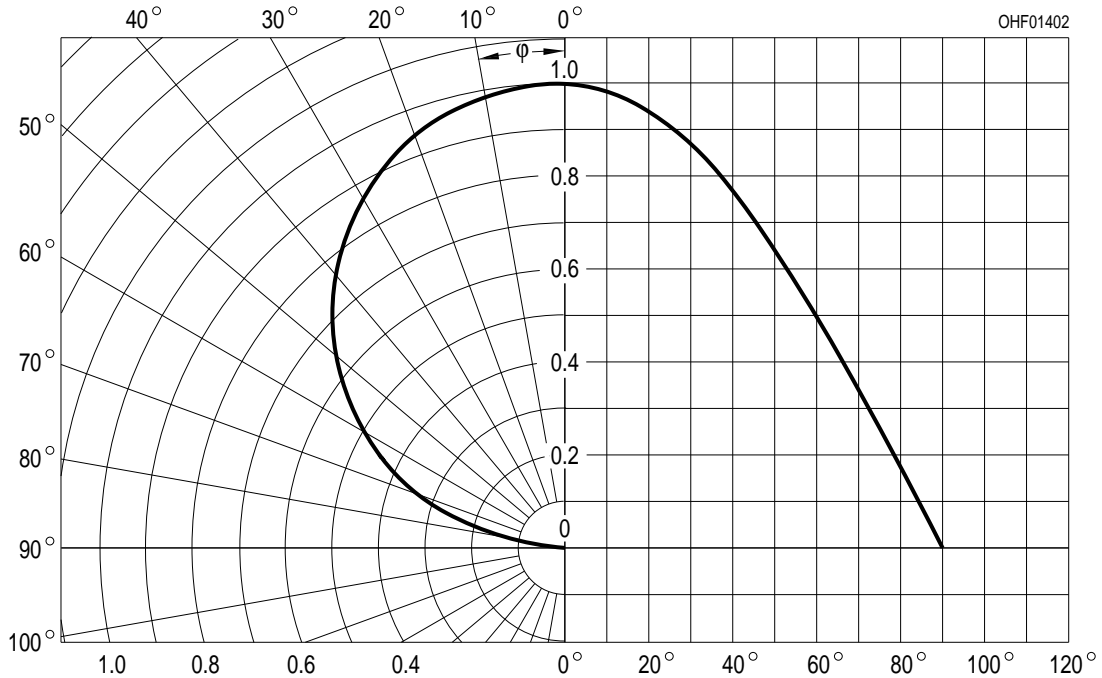
Dark Current ^{1) page 9}

$I_R = f(T_A), V_R = 10 \text{ V}, E = 0$

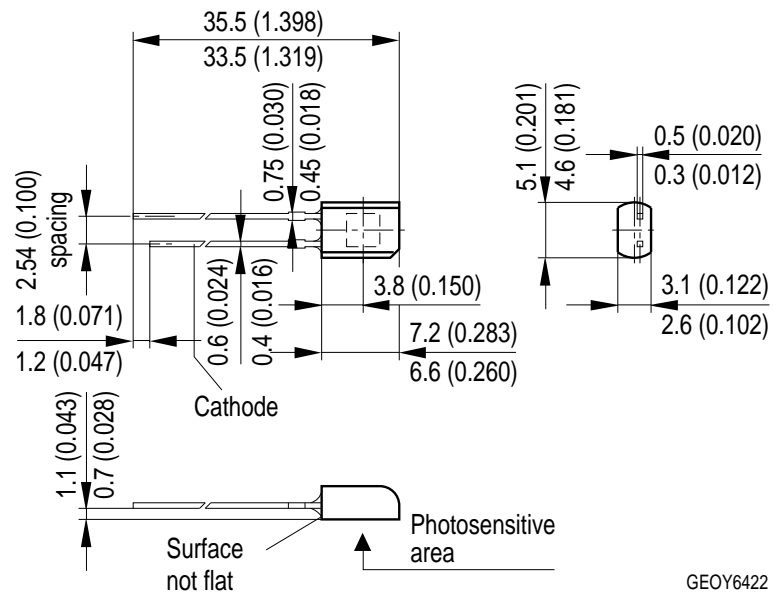


Directional Characteristics ^{1) page 9}

$S_{rel} = f(\phi)$



Package Outline



Dimensions in mm (inch).

Package

5mm Radial (T 1 ¾), Epoxy

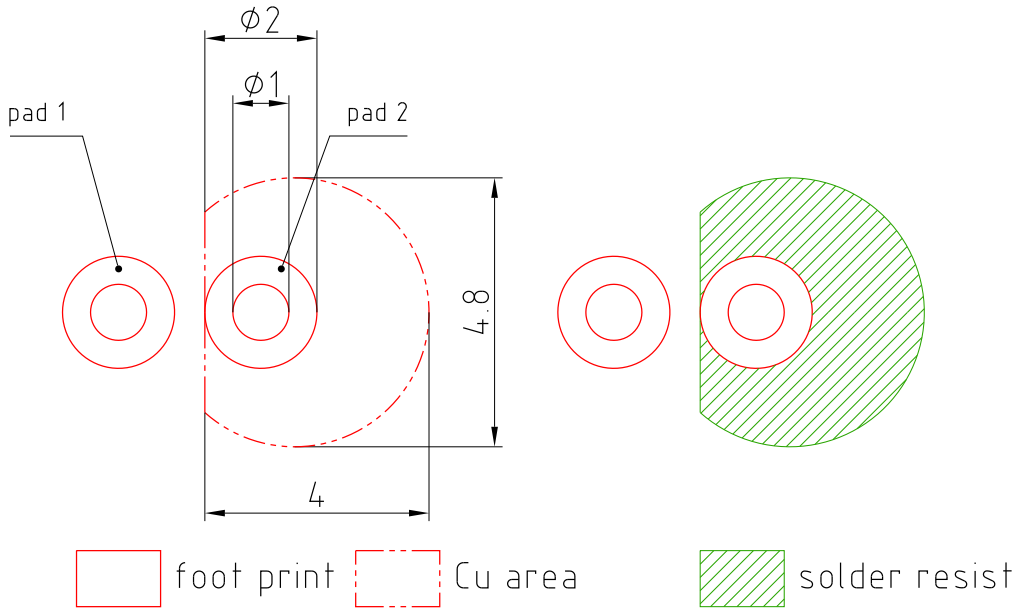
Approximate Weight:

0.1 g

Note

Packing information is available on the internet (online product catalog).

Recommended Solder Pad



E062.3010.188-01

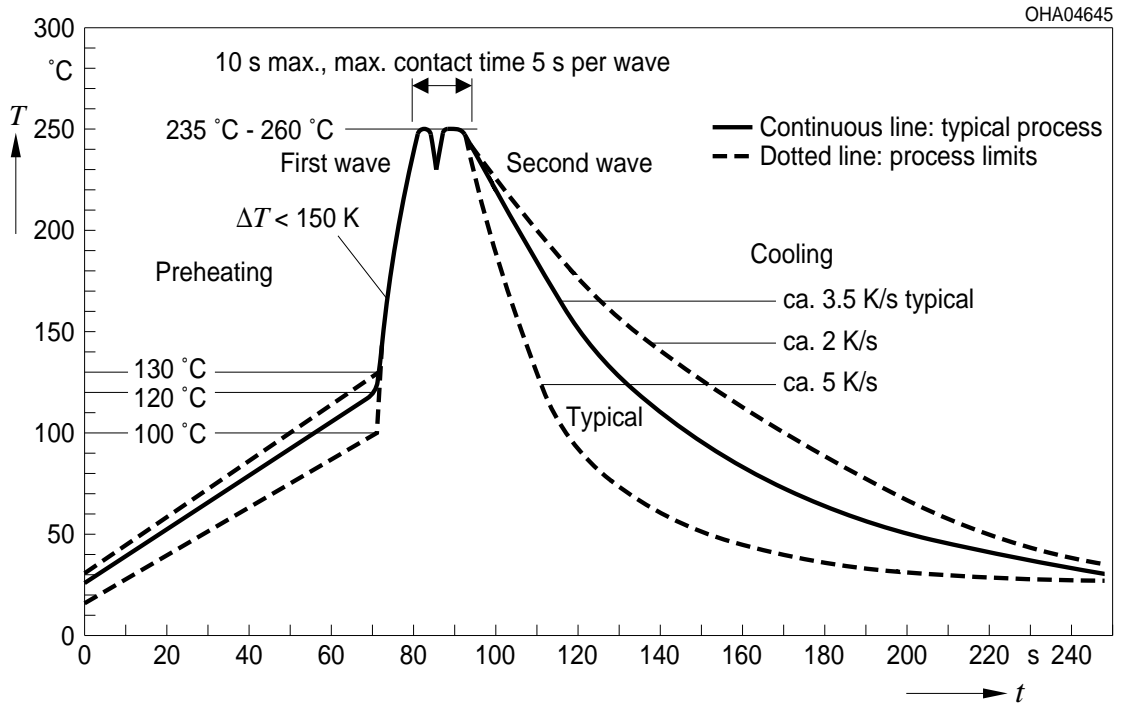
Dimensions in mm.

Note:

pad 1: anode

TTW Soldering

IEC-61760-1 TTW



Disclaimer

Language english will prevail in case of any discrepancies or deviations between the two language wordings.

Attention please!

The information describes the type of component and shall not be considered as assured characteristics.

Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version in the Internet.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office.

By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Components used in life-support devices or systems must be expressly authorized for such purpose!

Critical components* may only be used in life-support devices** or systems with the express written approval of OSRAM OS.

*) A critical component is a component used in a life-support device or system whose failure can reasonably be expected to cause the failure of that life-support device or system, or to affect its safety or the effectiveness of that device or system.

**) Life support devices or systems are intended (a) to be implanted in the human body, or (b) to support and/or maintain and sustain human life. If they fail, it is reasonable to assume that the health and the life of the user may be endangered.

Glossary

- ¹⁾ **Typical Values:** Due to the special conditions of the manufacturing processes of LED, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.

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